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RJK03B7DPA

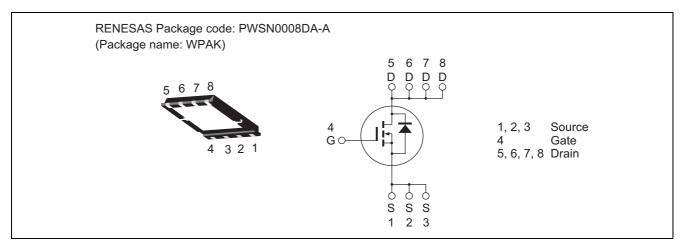
Silicon N Channel Power MOS FET **Power Switching**

> REJ03G1789-0200 Rev.2.00 Apr 03, 2009

Features

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance
 - $R_{DS(on)} \!= 6.0 \text{ m}\Omega$ typ. (at $V_{GS} \!= 10 \text{ V})$
- Pb-free
- Halogen-free

Outline



Absolute Maximum Ratings

| | | | $(Ta = 25^{\circ}C)$ |
|--|--------------------------------|-------------|----------------------|
| Item | Symbol | Ratings | Unit |
| Drain to source voltage | V _{DSS} | 30 | V |
| Gate to source voltage | V _{GSS} | ±20 | V |
| Drain current | ID | 30 | A |
| Drain peak current | Note1 I _{D(pulse)} | 120 | A |
| Body-drain diode reverse drain current | I _{DR} | 30 | A |
| Avalanche current | I _{AP} Note 2 | 12 | A |
| Avalanche energy | E _{AR} Note 2 | 14.4 | mJ |
| Channel dissipation | Pch Note3 | 30 | W |
| Channel to case thermal impedance | θch-c ^{Note3} | 4.17 | °C/W |
| Channel temperature | Tch | 150 | ٥C |
| Storage temperature | Tstg | -55 to +150 | °C |

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tch = 25° C, Rg $\geq 50 \Omega$

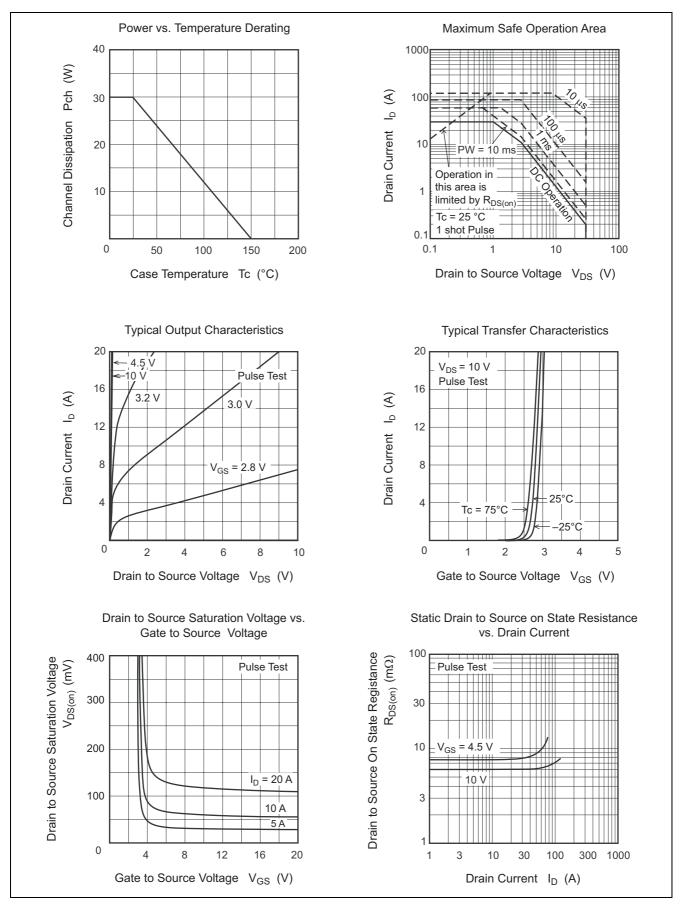
3. Tc = 25°C

Electrical Characteristics

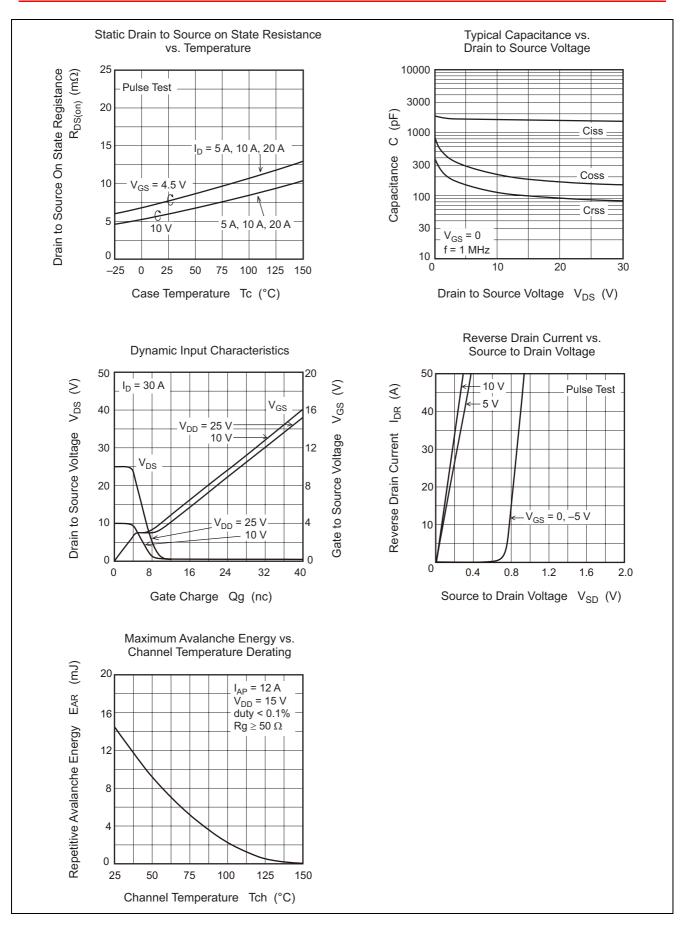
| Item | Symbol | Min | Тур | Max | Unit | Test Conditions |
|-----------------------------------|----------------------|-----|------|-------|------|--|
| Drain to source breakdown voltage | V _{(BR)DSS} | 30 | _ | | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| Gate to source leak current | I _{GSS} | | _ | ± 0.1 | μΑ | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain current | I _{DSS} | | — | 1 | μΑ | $V_{DS} = 30 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | V _{GS(off)} | 1.2 | _ | 2.5 | V | V _{DS} = 10 V, I _D = 1 mA |
| Static drain to source on state | R _{DS(on)} | _ | 6.0 | 7.8 | mΩ | $I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$ |
| resistance | R _{DS(on)} | _ | 7.7 | 10.7 | mΩ | $I_D = 15 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note4}$ |
| Forward transfer admittance | y _{fs} | _ | 80 | — | S | $I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$ |
| Input capacitance | Ciss | _ | 1670 | — | pF | V _{DS} = 10 V |
| Output capacitance | Coss | _ | 225 | — | pF | V _{GS} = 0 f = 1 MHz |
| Reverse transfer capacitance | Crss | _ | 115 | — | pF | |
| Gate Resistance | Rg | | 1.0 | — | Ω | |
| Total gate charge | Qg | | 11 | — | nC | V _{DD} = 10 V V _{GS} = 4.5 V I _D = 30 A |
| Gate to source charge | Qgs | | 5.0 | — | nC | |
| Gate to drain charge | Qgd | | 2.6 | — | nC | |
| Turn-on delay time | t _{d(on)} | | 9.6 | — | ns | $\begin{split} V_{GS} &= 10 \ V, \ I_D = 15 \ A \\ V_{DD} &\cong 10 \ V \\ R_L &= 0.67 \ \Omega \\ Rg &= 4.7 \ \Omega \end{split}$ |
| Rise time | tr | | 4.8 | — | ns | |
| Turn-off delay time | t _{d(off)} | | 37 | — | ns | |
| Fall time | t _f | | 5.2 | — | ns | |
| Body-drain diode forward voltage | V_{DF} | _ | 0.86 | 1.12 | V | $I_F = 30 \text{ A}, V_{GS} = 0^{\text{Note4}}$ |
| Body-drain diode reverse recovery | t _{rr} | _ | 15 | | ns | I _F =30 A, V _{GS} = 0 |
| time | | | | | | di _F / dt = 100 A/ μs |

Notes: 4. Pulse test

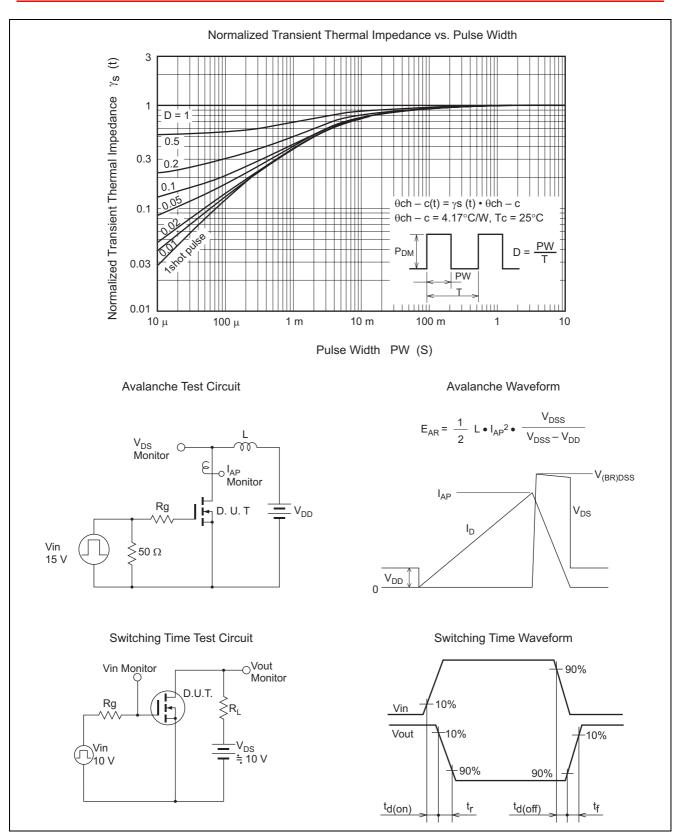
Main Characteristics



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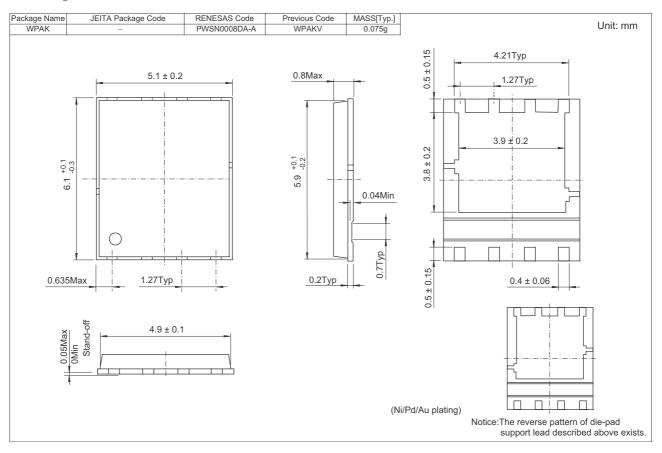


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Package Dimensions



Ordering Information

| Part No. | Quantity | Shipping Container |
|-------------------|----------|--------------------|
| RJK03B7DPA-00-J53 | 3000 pcs | Taping |

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